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### Understanding **Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	10260
Number of Logic Elements/Cells	244188
Total RAM Bits	12038144
Number of I/O	372
Number of Gates	-
Voltage - Supply	0.87V ~ 0.93V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	780-BBGA, FCBGA
Supplier Device Package	780-FBGA (29x29)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/intel/ep2agx260ef29c6">https://www.e-xfl.com/product-detail/intel/ep2agx260ef29c6</a>

Use the following with [Equation 1-1](#):

- $R_{SCAL}$  is the OCT resistance value at power up.
- $\Delta T$  is the variation of temperature with respect to the temperature at power up.
- $\Delta V$  is the variation of voltage with respect to the  $V_{CCIO}$  at power up.
- $dR/dT$  is the percentage change of  $R_{SCAL}$  with temperature.
- $dR/dV$  is the percentage change of  $R_{SCAL}$  with voltage.

[Table 1-14](#) lists the OCT variation with temperature and voltage after power-up calibration for Arria II GX devices.

**Table 1-14. OCT Variation after Power-up Calibration for Arria II GX Devices**

Nominal Voltage $V_{CCIO}$ (V)	$dR/dT$ (%/°C)	$dR/dV$ (%/mV)
3.0	0.262	0.035
2.5	0.234	0.039
1.8	0.219	0.086
1.5	0.199	0.136
1.2	0.161	0.288

[Table 1-15](#) lists the OCT variation with temperature and voltage after power-up calibration for Arria II GZ devices.

**Table 1-15. OCT Variation after Power-Up Calibration for Arria II GZ Devices (Note 1)**

Nominal Voltage, $V_{CCIO}$ (V)	$dR/dT$ (%/°C)	$dR/dV$ (%/mV)
3.0	0.189	0.0297
2.5	0.208	0.0344
1.8	0.266	0.0499
1.5	0.273	0.0744
1.2	0.317	0.1241

#### Note to Table 1-15:

(1) Valid for  $V_{CCIO}$  range of  $\pm 5\%$  and temperature range of 0° to 85°C.

#### Pin Capacitance

[Table 1-16](#) lists the pin capacitance for Arria II GX devices.

**Table 1-16. Pin Capacitance for Arria II GX Devices**

Symbol	Description	Typical	Unit
$C_{IO}$	Input capacitance on I/O pins, dual-purpose pins (differential I/O, clock, $R_{up}$ , $R_{dn}$ ), and dedicated clock input pins	7	pF

## I/O Standard Specifications

Table 1–22 through Table 1–35 list input voltage ( $V_{IH}$  and  $V_{IL}$ ), output voltage ( $V_{OH}$  and  $V_{OL}$ ), and current drive characteristics ( $I_{OH}$  and  $I_{OL}$ ) for various I/O standards supported by the Arria II device family. They also show the Arria II device family I/O standard specifications.  $V_{OL}$  and  $V_{OH}$  values are valid at the corresponding  $I_{OH}$  and  $I_{OL}$ , respectively.



For an explanation of terms used in Table 1–22 through Table 1–35, refer to “Glossary” on page 1–74.

Table 1–22 lists the single-ended I/O standards for Arria II GX devices.

**Table 1–22. Single-Ended I/O Standards for Arria II GX Devices**

I/O Standard	$V_{CCIO}$ (V)			$V_{IL}$ (V)		$V_{IH}$ (V)		$V_{OL}$ (V)	$V_{OH}$ (V)	$I_{OL}$ (mA)	$I_{OH}$ (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
3.3 V LVTTL	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.45	2.4	4	-4
3.3 V LVCMOS	3.135	3.3	3.465	-0.3	0.8	1.7	3.6	0.2	$V_{CCIO} - 0.2$	2	-2
3.0 V LVTTL	2.85	3	3.15	-0.3	0.8	1.7	$V_{CCIO} + 0.3$	0.45	2.4	4	-4
3.0 V LVCMOS	2.85	3	3.15	-0.3	0.8	1.7	$V_{CCIO} + 0.3$	0.2	$V_{CCIO} - 0.2$	0.1	-0.1
2.5 V LVCMOS	2.375	2.5	2.625	-0.3	0.7	1.7	$V_{CCIO} + 0.3$	0.4	2	1	-1
1.8 V LVCMOS	1.71	1.8	1.89	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	0.45	$V_{CCIO} - 0.45$	2	-2
1.5 V LVCMOS	1.425	1.5	1.575	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2
1.2 V LVCMOS	1.14	1.2	1.26	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2
3.0-V PCI	2.85	3	3.15	—	$0.3 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$	1.5	-0.5
3.0-V PCI-X	2.85	3	3.15	—	$0.35 \times V_{CCIO}$	$0.5 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.1 \times V_{CCIO}$	$0.9 \times V_{CCIO}$	1.5	-0.5

Table 1–23 lists the single-ended I/O standards for Arria II GZ devices.

**Table 1–23. Single-Ended I/O Standards for Arria II GZ Devices (Part 1 of 2)**

I/O Standard	$V_{CCIO}$ (V)			$V_{IL}$ (V)		$V_{IH}$ (V)		$V_{OL}$ (V)	$V_{OH}$ (V)	$I_{OL}$ (mA)	$I_{OH}$ (mA)
	Min	Typ	Max	Min	Max	Min	Max	Max	Min		
LVTTL	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.4	2.4	2	-2
LVCMOS	2.85	3	3.15	-0.3	0.8	1.7	3.6	0.2	$V_{CCIO} - 0.2$	0.1	-0.1
2.5 V	2.375	2.5	2.625	-0.3	0.7	1.7	3.6	0.4	2	1	-1
1.8 V	1.71	1.8	1.89	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	0.45	$V_{CCIO} - 0.45$	2	-2
1.5 V	1.425	1.5	1.575	-0.3	$0.35 \times V_{CCIO}$	$0.65 \times V_{CCIO}$	$V_{CCIO} + 0.3$	$0.25 \times V_{CCIO}$	$0.75 \times V_{CCIO}$	2	-2

## Switching Characteristics

This section provides performance characteristics of the Arria II GX and GZ core and periphery blocks for commercial grade devices. The following tables are considered final and are based on actual silicon characterization and testing. These numbers reflect the actual performance of the device under worst-case silicon process, voltage, and junction temperature conditions.

### Transceiver Performance Specifications

Table 1–34 lists the Arria II GX transceiver specifications.

**Table 1–34. Transceiver Specifications for Arria II GX Devices (Note 1) (Part 1 of 7)**

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit	
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max		
<b>Reference Clock</b>															
Supported I/O Standards	1.2-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS, and HCSL														
Input frequency from REFCLK input pins	—	50	—	622.08	50	—	622.08	50	—	622.08	50	—	622.08	MHz	
Input frequency from PLD input	—	50	—	200	50	—	200	50	—	200	50	—	200	MHz	
Absolute $V_{MAX}$ for a REFCLK pin	—	—	—	2.2	—	—	2.2	—	—	2.2	—	—	2.2	V	
Absolute $V_{MIN}$ for a REFCLK pin	—	-0.3	—	—	-0.3	—	—	-0.3	—	—	-0.3	—	—	V	
Rise/fall time (2)	—	—	—	0.2	—	—	0.2	—	—	0.2	—	—	0.2	UI	
Duty cycle	—	45	—	55	45	—	55	45	—	55	45	—	55	%	
Peak-to-peak differential input voltage	—	200	—	2000	200	—	2000	200	—	2000	200	—	2000	mV	
Spread-spectrum modulating clock frequency	PCIe	30	—	33	30	—	33	30	—	33	30	—	33	kHz	

**Table 1–34. Transceiver Specifications for Arria II GX Devices (Note 1) (Part 4 of 7)**

Symbol/ Description	Condition	I3			C4			C5 and I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Minimum peak-to-peak differential input voltage $V_{ID}$ (diff p-p)	—	100	—	—	100	—	—	100	—	—	100	—	—	mV
$V_{ICM}$	$V_{ICM} = 0.82\text{ V}$ setting	—	820	—	—	820	—	—	820	—	—	820	—	mV
	$V_{ICM} = 1.1\text{ V}$ setting (7)	—	1100	—	—	1100	—	—	1100	—	—	1100	—	mV
Differential on-chip termination resistors	100- $\Omega$ setting	—	100	—	—	100	—	—	100	—	—	100	—	$\Omega$
Return loss differential mode	PCIe	50 MHz to 1.25 GHz: -10dB												
	XAUI	100 MHz to 2.5 GHz: -10dB												
Return loss common mode	PCIe	50 MHz to 1.25 GHz: -6dB												
	XAUI	100 MHz to 2.5 GHz: -6dB												
Programmable PPM detector (8)	—	$\pm 62.5, 100, 125, 200,$ $250, 300, 500, 1000$												ppm
Run length	—	—	80	—	—	80	—	—	80	—	—	80	—	UI
Programmable equalization	—	—	—	7	—	—	7	—	—	7	—	—	7	dB
Signal detect/loss threshold	PCIe Mode	65	—	175	65	—	175	65	—	175	65	—	175	mV
CDR LTR time (9)	—	—	—	75	—	—	75	—	—	75	—	—	75	$\mu\text{s}$
CDR minimum T1b (10)	—	15	—	—	15	—	—	15	—	—	15	—	—	$\mu\text{s}$

**Table 1–34. Transceiver Specifications for Arria II GX Devices (Note 1) (Part 6 of 7)**

<b>Symbol/ Description</b>	<b>Condition</b>	<b>I3</b>			<b>C4</b>			<b>C5 and I5</b>			<b>C6</b>			<b>Unit</b>
		<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	
Intra-differential pair skew	—	—	—	15	—	—	15	—	—	15	—	—	15	ps
Intra-transceiver block skew	PCIe ×4	—	—	120	—	—	120	—	—	120	—	—	120	ps
Inter-transceiver block skew	PCIe ×8	—	—	300	—	—	300	—	—	300	—	—	300	ps
<b>CMU PLL0 and CMU PLL1</b>														
CMU PLL lock time from CMUPLL_reset deassertion	—	—	—	100	—	—	100	—	—	100	—	—	100	μs
<b>PLD-Transceiver Interface</b>														
Interface speed	—	25	—	320	25	—	240	25	—	240	25	—	200	MHz

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (*Note 1*) (Part 5 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
<b>SDI Transmitter Jitter Generation (8)</b>														
Alignment jitter (peak-to-peak)	Data rate = 1.485 Gbps (HD) pattern = Color Bar Low- frequency Roll-off = 100 KHz	0.2	—	—	0.2	—	—	0.2	—	—	0.2	—	—	UI
	Data rate = 2.97 Gbps (3G) pattern = Color bar Low- frequency Roll-off = 100 KHz	0.3	—	—	0.3	—	—	0.3	—	—	0.3	—	—	UI
<b>SDI Receiver Jitter Tolerance (8)</b>														
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 15 KHz  Data rate = 2.97 Gbps (3G) Pattern = single line scramble color bar	> 2		> 2		> 2		> 2		> 2		> 2		UI
	Jitter frequency = 100 KHz  Data rate = 2.97 Gbps (3G) Pattern = single line scramble color bar	> 0.3		> 0.3		> 0.3		> 0.3		> 0.3		> 0.3		UI
	Jitter frequency = 148.5 MHz  Data rate = 2.97 Gbps (3G) Pattern = single line scramble color bar	> 0.3		> 0.3		> 0.3		> 0.3		> 0.3		> 0.3		UI

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (*Note 1*) (Part 6 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 20 KHz  Data rate = 1.485 Gbps (HD) Pattern = 75% color bar	> 1			> 1			> 1			> 1			UI
	Jitter frequency = 100 KHz  Data rate = 1.485 Gbps (HD) Pattern = 75% color bar	> 0.2			> 0.2			> 0.2			> 0.2			UI
	Jitter frequency = 148.5 MHz  Data rate = 1.485 Gbps (HD) Pattern = 75% color bar	> 0.2			> 0.2			> 0.2			> 0.2			UI

**SATA Transmit Jitter Generation (10)**

Total jitter at 1.5 Gbps (G1)	Compliance pattern	—	—	0.55	—	—	0.55	—	—	0.55	—	—	0.55	UI
Deterministic jitter at 1.5 Gbps (G1)	Compliance pattern	—	—	0.35	—	—	0.35	—	—	0.35	—	—	0.35	UI
Total jitter at 3.0 Gbps (G2)	Compliance pattern	—	—	0.55	—	—	0.55	—	—	0.55	—	—	0.55	UI
Deterministic jitter at 3.0 Gbps (G2)	Compliance pattern	—	—	0.35	—	—	0.35	—	—	0.35	—	—	0.35	UI
Total jitter at 6.0 Gbps (G3)	Compliance pattern	—	—	0.52	—	—	—	—	—	—	—	—	—	UI
Random jitter at 6.0 Gbps (G3)	Compliance pattern	—	—	0.18	—	—	—	—	—	—	—	—	—	UI

**SATA Receiver Jitter Tolerance (10)**

Total jitter tolerance at 1.5 Gbps (G1)	Compliance pattern	> 0.65			> 0.65			> 0.65			> 0.65			UI
Deterministic jitter tolerance at 1.5 Gbps (G1)	Compliance pattern	> 0.35			> 0.35			> 0.35			> 0.35			UI
SSC modulation frequency at 1.5 Gbps (G1)	Compliance pattern	33			33			33			33			kHz

**Table 1–40. Transceiver Block Jitter Specifications for Arria II GX Devices (Note 1) (Part 10 of 10)**

Symbol/ Description	Conditions	I3			C4			C5, I5			C6			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Sinusoidal jitter tolerance at 3072 Mbps	Jitter frequency = 21.8 KHz Pattern = CJPAT	> 8.5			> 8.5			> 8.5			> 8.5			UI
	Jitter frequency = 1843.2 KHz to 20 MHz Pattern = CJPAT	> 0.1			> 0.1			> 0.1			> 0.1			UI

**Notes to Table 1–40:**

- (1) Dedicated `refclk` pins are used to drive the input reference clocks. The jitter numbers are valid for the stated conditions only.
- (2) The jitter numbers for SONET/SDH are compliant to the GR-253-CORE Issue 3 Specification.
- (3) The jitter numbers for XAUI are compliant to the IEEE802.3ae-2002 Specification.
- (4) The jitter numbers for PCIe are compliant to the PCIe Base Specification 2.0.
- (5) The jitter numbers for SRIO are compliant to the RapidIO Specification 1.3.
- (6) The jitter numbers for GIGE are compliant to the IEEE802.3-2002 Specification.
- (7) The jitter numbers for HiGig are compliant to the IEEE802.3ae-2002 Specification.
- (8) The HD-SDI and 3G-SDI jitter numbers are compliant to the SMPTE292M and SMPTE424M Specifications.
- (9) Arria II PCIe receivers are compliant to this specification provided the `VTX_CM-DC-ACTIVEIDLE-DELTA` of the upstream transmitter is less than 50 mV.
- (10) The jitter numbers for Serial Advanced Technology Attachment (SATA) are compliant to the Serial ATA Revision 3.0 Specification.
- (11) The jitter numbers for Common Public Radio Interface (CPRI) are compliant to the CPRI Specification V3.0.
- (12) The jitter numbers for Open Base Station Architecture Initiative (OBSAI) are compliant to the OBSAI RP3 Specification V4.1.

Table 1–41 lists the transceiver jitter specifications for all supported protocols for Arria II GZ devices.

**Table 1–41. Transceiver Block Jitter Specifications for Arria II GZ Devices (Note 1), (2) (Part 1 of 7)**

Symbol/ Description	Conditions	-C3 and -I3			-C4 and -I4			Unit
		Min	Typ	Max	Min	Typ	Max	
<b>SONET/SDH Transmit Jitter Generation (3)</b>								
Peak-to-peak jitter at 622.08 Mbps	Pattern = PRBS15	—	—	0.1	—	—	0.1	UI
RMS jitter at 622.08 Mbps	Pattern = PRBS15	—	—	0.01	—	—	0.01	UI
Peak-to-peak jitter at 2488.32 Mbps	Pattern = PRBS15	—	—	0.1	—	—	0.1	UI
RMS jitter at 2488.32 Mbps	Pattern = PRBS15	—	—	0.01	—	—	0.01	UI
<b>SONET/SDH Receiver Jitter Tolerance (3)</b>								
Jitter tolerance at 622.08 Mbps	Jitter frequency = 0.03 KHz Pattern = PRBS15	> 15			> 15			UI
	Jitter frequency = 25 KHz Pattern = PRBS15	> 1.5			> 1.5			UI
	Jitter frequency = 250 KHz Pattern = PRBS15	> 0.15			> 0.15			UI

**Table 1–41. Transceiver Block Jitter Specifications for Arria II GZ Devices (Note 1), (2) (Part 2 of 7)**

Symbol/ Description	Conditions	–C3 and –I3			–C4 and –I4			Unit
		Min	Typ	Max	Min	Typ	Max	
Jitter tolerance at 2488.32 Mbps	Jitter frequency = 0.06 KHz Pattern = PRBS15	> 15		> 15		> 15		UI
	Jitter frequency = 100 KHZ Pattern = PRBS15	> 1.5		> 1.5		> 1.5		UI
	Jitter frequency = 1 MHz Pattern = PRBS15	> 0.15		> 0.15		> 0.15		UI
	Jitter frequency = 10 MHz Pattern = PRBS15	> 0.15		> 0.15		> 0.15		UI
<b>Fibre Channel Transmit Jitter Generation (4), (5)</b>								
Total jitter FC-1	Pattern = CRPAT	—	—	0.23	—	—	0.23	UI
Deterministic jitter FC-1	Pattern = CRPAT	—	—	0.11	—	—	0.11	UI
Total jitter FC-2	Pattern = CRPAT	—	—	0.33	—	—	0.33	UI
Deterministic jitter FC-2	Pattern = CRPAT	—	—	0.2	—	—	0.2	UI
Total jitter FC-4	Pattern = CRPAT	—	—	0.52	—	—	0.52	UI
Deterministic jitter FC-4	Pattern = CRPAT	—	—	0.33	—	—	0.33	UI
<b>Fibre Channel Receiver Jitter Tolerance (4), (6)</b>								
Deterministic jitter FC-1	Pattern = CJTPAT	> 0.37		> 0.37		> 0.37		UI
Random jitter FC-1	Pattern = CJTPAT	> 0.31		> 0.31		> 0.31		UI
Sinusoidal jitter FC-1	Fc/25000	> 1.5		> 1.5		> 1.5		UI
	Fc/1667	> 0.1		> 0.1		> 0.1		UI
Deterministic jitter FC-2	Pattern = CJTPAT	> 0.33		> 0.33		> 0.33		UI
Random jitter FC-2	Pattern = CJTPAT	> 0.29		> 0.29		> 0.29		UI
Sinusoidal jitter FC-2	Fc/25000	> 1.5		> 1.5		> 1.5		UI
	Fc/1667	> 0.1		> 0.1		> 0.1		UI
Deterministic jitter FC-4	Pattern = CJTPAT	> 0.33		> 0.33		> 0.33		UI
Random jitter FC-4	Pattern = CJTPAT	> 0.29		> 0.29		> 0.29		UI
Sinusoidal jitter FC-4	Fc/25000	> 1.5		> 1.5		> 1.5		UI
	Fc/1667	> 0.1		> 0.1		> 0.1		UI
<b>XAU1 Transmit Jitter Generation (7)</b>								
Total jitter at 3.125 Gbps	Pattern = CJPAT	—	—	0.3	—	—	0.3	UI
Deterministic jitter at 3.125 Gbps	Pattern = CJPAT	—	—	0.17	—	—	0.17	UI
<b>XAU1 Receiver Jitter Tolerance (7)</b>								
Total jitter	—	> 0.65		> 0.65		> 0.65		UI
Deterministic jitter	—	> 0.37		> 0.37		> 0.37		UI

**Table 1–41. Transceiver Block Jitter Specifications for Arria II GZ Devices (Note 1), (2) (Part 3 of 7)**

Symbol/ Description	Conditions	–C3 and –I3			–C4 and –I4			Unit
		Min	Typ	Max	Min	Typ	Max	
Peak-to-peak jitter	Jitter frequency = 22.1 KHz	> 8.5		> 8.5		> 8.5		UI
Peak-to-peak jitter	Jitter frequency = 1.875 MHz	> 0.1		> 0.1		> 0.1		UI
Peak-to-peak jitter	Jitter frequency = 20 MHz	> 0.1		> 0.1		> 0.1		UI
<b>PCIe Transmit Jitter Generation (8)</b>								
Total jitter at 2.5 Gbps (Gen1)—x1, x4, and x8	Compliance pattern	—	—	0.25	—	—	0.25	UI
Total jitter at 5 Gbps (Gen2)—x1, x4, and x8	Compliance pattern	—	—	0.25	—	—	—	UI
<b>PCIe Receiver Jitter Tolerance (8)</b>								
Total jitter at 2.5 Gbps (Gen1)	Compliance pattern	> 0.6		> 0.6		UI		UI
Total jitter at 5 Gbps (Gen2)	Compliance pattern	Not supported		Not supported		UI		UI
<b>PCIe (Gen 1) Electrical Idle Detect Threshold</b>								
V <sub>RX-IDLE-DETDIFFp-p</sub> (9)	Compliance pattern	65	—	175	65	—	175	UI
<b>SRIO Transmit Jitter Generation (10)</b>								
Deterministic jitter (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	—	—	0.17	—	—	0.17	UI
Total jitter (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	—	—	0.35	—	—	0.35	UI
<b>SRIO Receiver Jitter Tolerance (10)</b>								
Deterministic jitter tolerance (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.37		> 0.37		UI		UI
Combined deterministic and random jitter tolerance (peak-to-peak)	Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.55		> 0.55		UI		UI
Sinusoidal jitter tolerance (peak-to-peak)	Jitter frequency = 22.1 KHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 8.5		> 8.5		UI		UI
	Jitter frequency = 1.875 MHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.1		> 0.1		UI		UI
	Jitter frequency = 20 MHz Data rate = 1.25, 2.5, 3.125 Gbps Pattern = CJPAT	> 0.1		> 0.1		UI		UI
<b>GIGE Transmit Jitter Generation (11)</b>								
Deterministic jitter (peak-to-peak)	Pattern = CRPAT	—	—	0.14	—	—	0.14	UI
Total jitter (peak-to-peak)	Pattern = CRPAT	—	—	0.279	—	—	0.279	UI

## Core Performance Specifications for the Arria II Device Family

This section describes the clock tree, phase-locked loop (PLL), digital signal processing (DSP), embedded memory, configuration, and JTAG specifications for Arria II GX and GZ devices.

### Clock Tree Specifications

Table 1–42 lists the clock tree specifications for Arria II GX devices.

**Table 1–42. Clock Tree Performance for Arria II GX Devices**

Clock Network	Performance			Unit
	I3, C4	C5,I5	C6	
GCLK and RCLK	500	500	400	MHz
PCLK	420	350	280	MHz

Table 1–43 lists the clock tree specifications for Arria II GZ devices.

**Table 1–43. Clock Tree Performance for Arria II GZ Devices**

Clock Network	Performance		Unit
	-C3 and -I3	-C4 and -I4	
GCLK and RCLK	700	500	MHz
PCLK	500	450	MHz

### PLL Specifications

Table 1–44 lists the PLL specifications for Arria II GX devices.

**Table 1–44. PLL Specifications for Arria II GX Devices (Part 1 of 3)**

Symbol	Description	Min	Typ	Max	Unit
$f_{IN}$	Input clock frequency (from clock input pins residing in right/top/bottom banks) (-4 Speed Grade)	5	—	670 (1)	MHz
	Input clock frequency (from clock input pins residing in right/top/bottom banks) (-5 Speed Grade)	5	—	622 (1)	MHz
	Input clock frequency (from clock input pins residing in right/top/bottom banks) (-6 Speed Grade)	5	—	500 (1)	MHz
$f_{INPFD}$	Input frequency to the PFD	5	—	325	MHz
$f_{VCO}$	PLL VCO operating Range (2)	600	—	1,400	MHz
$f_{INDUTY}$	Input clock duty cycle	40	—	60	%
$f_{EINDUTY}$	External feedback clock input duty cycle	40	—	60	%
$t_{INCCJ}$ (3), (4)	Input clock cycle-to-cycle jitter (Frequency $\geq$ 100 MHz)	—	—	0.15	UI (p–p)
	Input clock cycle-to-cycle jitter (Frequency $\leq$ 100 MHz)	—	—	$\pm 750$	ps (p–p)

**Table 1–44. PLL Specifications for Arria II GX Devices (Part 2 of 3)**

<b>Symbol</b>	<b>Description</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$f_{\text{OUT}}$	Output frequency for internal global or regional clock (-4 Speed Grade)	—	—	500	MHz
	Output frequency for internal global or regional clock (-5 Speed Grade)	—	—	500	MHz
	Output frequency for internal global or regional clock (-6 Speed Grade)	—	—	400	MHz
$f_{\text{OUT\_EXT}}$	Output frequency for external clock output (-4 Speed Grade)	—	—	670 (5)	MHz
	Output frequency for external clock output (-5 Speed Grade)	—	—	622 (5)	MHz
	Output frequency for external clock output (-6 Speed Grade)	—	—	500 (5)	MHz
$t_{\text{OUTDUTY}}$	Duty cycle for external clock output (when set to 50%)	45	50	55	%
$t_{\text{OUTPJ\_DC}}$	Dedicated clock output period jitter ( $f_{\text{OUT}} \geq 100$ MHz)	—	—	300	ps (p-p)
	Dedicated clock output period jitter ( $f_{\text{OUT}} < 100$ MHz)	—	—	30	mUI (p-p)
$t_{\text{OUTCCJ\_DC}}$	Dedicated clock output cycle-to-cycle jitter ( $f_{\text{OUT}} \geq 100$ MHz)	—	—	300	ps (p-p)
	Dedicated clock output cycle-to-cycle jitter ( $f_{\text{OUT}} < 100$ MHz)	—	—	30	mUI (p-p)
$f_{\text{OUTPJ\_IO}}$	Regular I/O clock output period jitter ( $f_{\text{OUT}} \geq 100$ MHz)	—	—	650	ps (p-p)
	Regular I/O clock output period jitter ( $f_{\text{OUT}} < 100$ MHz)	—	—	65	mUI (p-p)
$f_{\text{OUTCCJ\_IO}}$	Regular I/O clock output cycle-to-cycle jitter ( $f_{\text{OUT}} \geq 100$ MHz)	—	—	650	ps (p-p)
	Regular I/O clock output cycle-to-cycle jitter ( $f_{\text{OUT}} < 100$ MHz)	—	—	65	mUI (p-p)
$t_{\text{CONFIGPLL}}$	Time required to reconfigure PLL scan chains	—	3.5	—	SCANCLK cycles
$t_{\text{CONFIGPHASE}}$	Time required to reconfigure phase shift	—	1	—	SCANCLK cycles
$f_{\text{SCANCLK}}$	SCANCLK frequency	—	—	100	MHz
$t_{\text{LOCK}}$	Time required to lock from end of device configuration	—	—	1	ms
$t_{\text{DLLOCK}}$	Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays)	—	—	1	ms
$f_{\text{CLBW}}$	PLL closed-loop low bandwidth	—	0.3	—	MHz
	PLL closed-loop medium bandwidth	—	1.5	—	MHz
	PLL closed-loop high bandwidth	—	4	—	MHz
$t_{\text{PLL\_PSERR}}$	Accuracy of PLL phase shift	—	—	$\pm 50$	ps
$t_{\text{ARESET}}$	Minimum pulse width on areset signal	10	—	—	ns

**Table 1–45. PLL Specifications for Arria II GZ Devices (Part 2 of 2)**

<b>Symbol</b>	<b>Parameter</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$t_{DLOCK}$	Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays)	—	—	1	ms
$f_{CLBW}$	PLL closed-loop low bandwidth	—	0.3	—	MHz
	PLL closed-loop medium bandwidth	—	1.5	—	MHz
	PLL closed-loop high bandwidth (7)	—	4	—	MHz
$t_{PLL\_PSERR}$	Accuracy of PLL phase shift	—	—	$\pm 50$	ps
$t_{ARESET}$	Minimum pulse width on the <code>areset</code> signal	10	—	—	ns
$t_{INCCJ} \text{ (3), (4)}$	Input clock cycle to cycle jitter ( $F_{REF} \geq 100$ MHz)	—	—	0.15	UI (p-p)
	Input clock cycle to cycle jitter ( $F_{REF} < 100$ MHz)	—	—	$\pm 750$	ps (p-p)
$t_{OUTPJ\_DC} \text{ (5)}$	Period Jitter for dedicated clock output ( $F_{OUT} \geq 100$ MHz)	—	—	175	ps (p-p)
	Period Jitter for dedicated clock output ( $F_{OUT} < 100$ MHz)	—	—	17.5	mUI (p-p)
$t_{OUTCCJ\_DC} \text{ (5)}$	Cycle to Cycle Jitter for dedicated clock output ( $F_{OUT} \geq 100$ MHz)	—	—	175	ps (p-p)
	Cycle to Cycle Jitter for dedicated clock output ( $F_{OUT} < 100$ MHz)	—	—	17.5	mUI (p-p)
$t_{OUTPJ\_IO} \text{ (5), (8)}$	Period Jitter for clock output on regular I/O ( $F_{OUT} \geq 100$ MHz)	—	—	600	ps (p-p)
	Period Jitter for clock output on regular I/O ( $F_{OUT} < 100$ MHz)	—	—	60	mUI (p-p)
$t_{OUTCCJ\_IO} \text{ (5), (8)}$	Cycle to Cycle Jitter for clock output on regular I/O ( $F_{OUT} \geq 100$ MHz)	—	—	600	ps (p-p)
	Cycle to Cycle Jitter for clock output on regular I/O ( $F_{OUT} < 100$ MHz)	—	—	60	mUI (p-p)
$t_{CASC\_OUTPJ\_DC} \text{ (5), (6)}$	Period Jitter for dedicated clock output in cascaded PLLs ( $F_{OUT} \geq 100$ MHz)	—	—	250	ps (p-p)
	Period Jitter for dedicated clock output in cascaded PLLs ( $F_{OUT} < 100$ MHz)	—	—	25	mUI (p-p)
$f_{DRIFT}$	Frequency drift after PFDENA is disabled for duration of 100 us	—	—	$\pm 10$	%

**Notes to Table 1–45:**

- (1) This specification is limited in the Quartus II software by the I/O maximum frequency. The maximum I/O frequency is different for each I/O standard.
- (2) This specification is limited by the lower of the two: I/O  $F_{MAX}$  or  $F_{OUT}$  of the PLL.
- (3) A high input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean clock source that is less than 120 ps.
- (4)  $F_{REF}$  is  $f_{IN/N}$  when  $N = 1$ .
- (5) Peak-to-peak jitter with a probability level of  $10^{-12}$  (14 sigma, 99.9999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied. The external memory interface clock output jitter specifications use a different measurement method and are available in [Table 1–64 on page 1–71](#).
- (6) The cascaded PLL specification is only applicable with the following condition:
  - a. Upstream PLL:  $0.59$  MHz  $\leq$  Upstream PLL BW  $< 1$  MHz
  - b. Downstream PLL: Downstream PLL BW  $> 2$  MHz
- (7) High bandwidth PLL settings are not supported in external feedback mode.
- (8) External memory interface clock output jitter specifications use a different measurement method, which is available in [Table 1–63 on page 1–71](#).

## Periphery Performance

This section describes periphery performance, including high-speed I/O, external memory interface, and IOE programmable delay.

I/O performance supports several system interfaces, for example the high-speed I/O interface, external memory interface, and the PCI/PCI-X bus interface. I/O using SSTL-18 Class I termination standard can achieve up to the stated DDR2 SDRAM interfacing speed with typical DDR2 SDRAM memory interface setup. I/O using general purpose I/O (GPIO) standards such as 3.0, 2.5, 1.8, or 1.5 LVTT/LVCMOS are capable of typical 200 MHz interfacing frequency with 10pF load.



Actual achievable frequency depends on design- and system-specific factors. You should perform HSPICE/IBIS simulations based on your specific design and system setup to determine the maximum achievable frequency in your system.

### High-Speed I/O Specification

Table 1–53 lists the high-speed I/O timing for Arria II GX devices.

**Table 1–53. High-Speed I/O Specifications for Arria II GX Devices (Part 1 of 4)**

Symbol	Conditions	I3		C4		C5,I5		C6		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
<b>Clock</b>										
$f_{HSCLK\_IN}$ (input clock frequency)—Row I/O	Clock boost factor, W = 1 to 40 (1)	5	670	5	670	5	622	5	500	MHz
$f_{HSCLK\_IN}$ (input clock frequency)—Column I/O	Clock boost factor, W = 1 to 40 (1)	5	500	5	500	5	472.5	5	472.5	MHz
$f_{HSCLK\_OUT}$ (output clock frequency)—Row I/O	—	5	670	5	670	5	622	5	500	MHz
$f_{HSCLK\_OUT}$ (output clock frequency)—Column I/O	—	5	500	5	500	5	472.5	5	472.5	MHz

**Table 1–53. High-Speed I/O Specifications for Arria II GX Devices (Part 3 of 4)**

<b>Symbol</b>	<b>Conditions</b>	<b>I3</b>		<b>C4</b>		<b>C5,I5</b>		<b>C6</b>		<b>Unit</b>
		<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>	
$t_{TX\_JITTER}$ (4)	True LVDS with dedicated SERDES (data rate 600–1,250 Mbps)	—	175	—	175	—	225	—	300	ps
	True LVDS with dedicated SERDES (data rate < 600 Mbps)	—	0.105	—	0.105	—	0.135	—	0.18	UI
	True LVDS and emulated LVDS_E_3R with logic elements as SERDES (data rate 600 – 945 Mbps)	—	260	—	260	—	300	—	350	ps
	True LVDS and emulated LVDS_E_3R with logic elements as SERDES (data rate < 600 Mbps)	—	0.16	—	0.16	—	0.18	—	0.21	UI
$t_{TX\_DCD}$	True LVDS and emulated LVDS_E_3R	45	55	45	55	45	55	45	55	%
$t_{RISE}$ and $t_{FALL}$	True LVDS and emulated LVDS_E_3R	—	200	—	200	—	225	—	250	ps
TCCS	True LVDS (5)	—	150	—	150	—	175	—	200	ps
	Emulated LVDS_E_3R	—	200	—	200	—	250	—	300	ps
<b>Receiver (6)</b>										
True differential I/O standards - $f_{HSDRDPA}$ (data rate)	SERDES factor J = 3 to 10	150	1250	150	1250	150	1050	150	840	Mbps

**Table 1–53. High-Speed I/O Specifications for Arria II GX Devices (Part 4 of 4)**

<b>Symbol</b>	<b>Conditions</b>	<b>I3</b>		<b>C4</b>		<b>C5,I5</b>		<b>C6</b>		<b>Unit</b>
		<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>	<b>Min</b>	<b>Max</b>	
$f_{HSDR}$ (data rate)	SERDES factor J = 3 to 10	(3)	945 (7)	(3)	945 (7)	(3)	740 (7)	(3)	640 (7)	Mbps
	SERDES factor J = 2 (using DDR registers)	(3)	(7)	(3)	(7)	(3)	(7)	(3)	(7)	Mbps
	SERDES factor J = 1 (using SDR registers)	(3)	(7)	(3)	(7)	(3)	(7)	(3)	(7)	Mbps
Soft-CDR PPM tolerance	Soft-CDR mode	—	300	—	300	—	300	—	300	±PPM
DPA run length	DPA mode	—	10,000	—	10,000	—	10,000	—	10,000	UI
Sampling window (SW)	Non-DPA mode (5)	—	300	—	300	—	350	—	400	ps

**Notes to Table 1–53:**

- (1)  $f_{HSCLK\_IN} = f_{HSDR} / W$ . Use W to determine the supported selection of input reference clock frequencies for the desired data rate.
- (2) Applicable for interfacing with DPA receivers only. For interfacing with non-DPA receivers, you must calculate the leftover timing margin in the receiver by performing link timing closure analysis. For Arria II GX transmitter to Arria II GX non-DPA receiver, the maximum supported data rate is 945 Mbps. For data rates above 840 Mbps, perform PCB trace compensation by adjusting the PCB trace length for LVDS channels to improve channel-to-channel skews.
- (3) The minimum and maximum specification depends on the clock source (for example, PLL and clock pin) and the clock routing resource you use (global, regional, or local). The I/O differential buffer and input register do not have a minimum toggle rate.
- (4) The specification is only applicable under the influence of core noise.
- (5) Applicable for true LVDS using dedicated SERDES only.
- (6) Dedicated SERDES and DPA features are only available on the right banks.
- (7) You must calculate the leftover timing margin in the receiver by performing link timing closure analysis. You must consider the board skew margin, transmitter channel-to-channel skew, and the receiver sampling margin to determine the leftover timing margin.

Table 1–54 lists the high-speed I/O timing for Arria II GZ devices.

**Table 1–54. High-Speed I/O Specifications for Arria II GZ Devices (Note 1), (2), (10) (Part 1 of 3)**

<b>Symbol</b>	<b>Conditions</b>	<b>C3, I3</b>			<b>C4, I4</b>			<b>Unit</b>
		<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	
<b>Clock</b>								
$f_{HSCLK\_in}$ (input clock frequency) true differential I/O standards	Clock boost factor W = 1 to 40 (3)	5	—	717	5	—	717	MHz
$f_{HSCLK\_in}$ (input clock frequency) single ended I/O standards (9)	Clock boost factor W = 1 to 40 (3)	5	—	717	5	—	717	MHz
$f_{HSCLK\_in}$ (input clock frequency) single ended I/O standards (10)	Clock boost factor W = 1 to 40 (3)	5	—	420	5	—	420	MHz

**Table 1–57. External Memory Interface Specifications for Arria II GX Devices (Part 2 of 2)**

Frequency Mode	Frequency Range (MHz)			Resolution (°)	DQS Delay Buffer Mode (1)	Number of Delay Chains
	C4	I3, C5, I5	C6			
5	270-410	270-380	270-320	36	High	10
6	320-450	320-410	320-370	45	High	8

**Note to Table 1–57:**

- (1) Low indicates a 6-bit DQS delay setting; high indicates a 5-bit DQS delay setting.

Table 1–58 lists the DLL frequency range specifications for Arria II GZ devices.

**Table 1–58. DLL Frequency Range Specifications for Arria II GZ Devices**

Frequency Mode	Frequency Range (MHz)		Available Phase Shift	DQS Delay Buffer Mode (1)	Number of Delay Chains
	-3	-4			
0	90-130	90-120	22.5°, 45°, 67.5°, 90°	Low	16
1	120-170	120-160	30°, 60°, 90°, 120°	Low	12
2	150-210	150-200	36°, 72°, 108°, 144°	Low	10
3	180-260	180-240	45°, 90°, 135°, 180°	Low	8
4	240-320	240-290	30°, 60°, 90°, 120°	High	12
5	290-380	290-360	36°, 72°, 108°, 144°	High	10
6	360-450	360-450	45°, 90°, 135°, 180°	High	8
7	470-630	470-590	60°, 120°, 180°, 240°	High	6

**Note to Table 1–58:**

- (1) Low indicates a 6-bit DQS delay setting; high indicates a 5-bit DQS delay setting.

Table 1–59 lists the DQS phase offset delay per stage for Arria II GX devices.

**Table 1–59. DQS Phase Offset Delay Per Setting for Arria II GX Devices (Note 1), (2), (3)**

Speed Grade	Min	Max	Unit
C4	7.0	13.0	ps
I3, C5, I5	7.0	15.0	ps
C6	8.5	18.0	ps

**Notes to Table 1–59:**

- (1) The valid settings for phase offset are -64 to +63 for frequency modes 0 to 3 and -32 to +31 for frequency modes 4 to 5.  
(2) The typical value equals the average of the minimum and maximum values.  
(3) The delay settings are linear.

## I/O Timing

Altera offers two ways to determine I/O timing:

- Using the Microsoft Excel-based I/O Timing.
- Using the Quartus II Timing Analyzer.

The Microsoft Excel-based I/O Timing provides pin timing performance for each device density and speed grade. The data is typically used prior to designing the FPGA to get an estimate of the timing budget as part of the link timing analysis. The Quartus II timing analyzer provides a more accurate and precise I/O timing data based on the specifics of the design after place-and-route is complete.

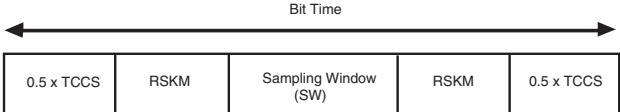
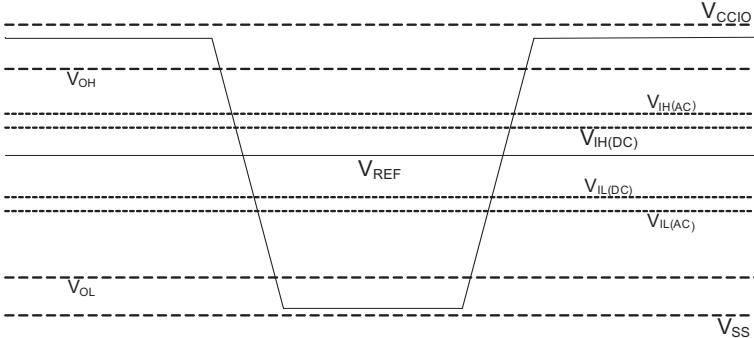


The Microsoft Excel-based I/O Timing spreadsheet is downloadable from the [Literature: Arria II Devices](#) web page.

**Table 1–68. Glossary (Part 2 of 4)**

Letter	Subject	Definitions
G, H, I, J	J JTAG Timing Specifications	<p>High-speed I/O block: Deserialization factor (width of parallel data bus).</p> <p>JTAG Timing Specifications:</p> <p>The diagram illustrates the timing sequence for JTAG operations. It shows four signals: TMS, TDI, TCK, and TDO. TMS and TDI are high-speed parallel data buses. TCK is a clock signal. TDO is the output data. Various timing parameters are labeled: <math>t_{JCP}</math> (TMS setup time), <math>t_{JCH}</math> (TMS hold time), <math>t_{JCL}</math> (TDI setup time), <math>t_{JPSU}</math> (TDI hold time), <math>t_{JPH}</math> (TDO hold time), <math>t_{JPZX}</math> (TDO setup time), <math>t_{JPZO}</math> (TDO hold time), and <math>t_{JPXZ}</math> (TDO transition time).</p>
K, L, M, N, O, P	PLL Specifications	<p>PLL Specification parameters:</p> <p><b>Diagram of PLL Specifications (1)</b></p> <p>The diagram shows a detailed block diagram of a PLL. It includes a Core Clock input, a Synchronizer, a Phase Frequency Detector (PFD), a Charge Pump (CP), a Loop Filter (LF), a Voltage Controlled Oscillator (VCO), a VCO post-scale counter K (with a value of 2), a Counter CO.C9, and various output paths for CLKOUT pins, GCLK, and RCLK. A feedback path from the output is labeled "External Feedback". A key legend indicates that blue boxes represent "Reconfigurable in User Mode".</p> <p><b>Notes:</b></p> <ul style="list-style-type: none"> <li>(1) CoreClock can only be fed by dedicated clock input pins or PLL outputs.</li> <li>(2) This is the VCO post-scale counter K.</li> </ul>
Q, R	$R_L$	Receiver differential input discrete resistor (external to the Arria II device).

**Table 1-68. Glossary (Part 3 of 4)**

Letter	Subject	Definitions
	<b>SW (sampling window)</b>	The period of time during which the data must be valid in order to capture it correctly. The setup and hold times determine the ideal strobe position within the sampling window: <i>Timing Diagram</i> 
S	Single-ended Voltage Referenced I/O Standard	The JEDEC standard for SSTL and HSTL I/O standards define both the AC and DC input signal values. The AC values indicate the voltage levels at which the receiver must meet its timing specifications. The DC values indicate the voltage levels at which the final logic state of the receiver is unambiguously defined. After the receiver input has crossed the AC value, the receiver changes to the new logic state. The new logic state is then maintained as long as the input stays beyond the AC threshold. This approach is intended to provide predictable receiver timing in the presence of input waveform ringing: <i>Single-Ended Voltage Referenced I/O Standard</i> 
T	<b>t<sub>C</sub></b>	High-speed receiver and transmitter input and output clock period.
	<b>TCCS (channel-to-channel-skew)</b>	The timing difference between the fastest and slowest output edges, including $t_{CO}$ variation and clock skew, across channels driven by the same PLL. The clock is included in the TCCS measurement (refer to the <i>Timing Diagram</i> figure under S in this table).
	<b>t<sub>DUTY</sub></b>	High-speed I/O block: Duty cycle on the high-speed transmitter output clock. <b>Timing Unit Interval (TUI)</b> The timing budget allowed for skew, propagation delays, and data sampling window. ( $TUI = 1 / (\text{Receiver Input Clock Frequency Multiplication Factor}) = t_c/w$ )
	<b>t<sub>FALL</sub></b>	Signal high-to-low transition time (80-20%)
	<b>t<sub>INCCJ</sub></b>	Cycle-to-cycle jitter tolerance on the PLL clock input.
	<b>t<sub>OUTPJ_IO</sub></b>	Period jitter on the general purpose I/O driven by a PLL.
	<b>t<sub>OUTPJ_DC</sub></b>	Period jitter on the dedicated clock output driven by a PLL.
	<b>t<sub>RISE</sub></b>	Signal low-to-high transition time (20-80%).